

PRODUCT DATASHEET

Gas Discharge Tubes





Description -

Gas discharge tubes (GDT) use noble gasses enclosed in ceramic tubes to provide an alternate circuit path for voltage spikes. The ceramic envelope and with nickel connectors allow for high loads. The breakdown voltages of the devices have a wide range (up to 20% olerance). Major applications are high requency telecommunication lines, stations, security systems, HID and high quality Surge Protection Devices.

Applications

- Communication equipment
- CATV equipment
- Test equipment
- Data lines
- Power supplies
- Telecom SLIC protection
- Telecommunications

Features

- RoHS & HF compliant
- Low Capacitance
- Micro-Gap Design
- Stable breakdown voltage
- High insulation resistance
- High holdover voltage
- Large absorbing transient current capability

Electriacl Characteristics

Part No.	DC Spark-over Voltage 100V/S(V)	Max.Impulse Spark-over Voltage 1KV/µs(V)	Nominal Discharge Current(L) 1s,50Hz(A)	Nominal Impulse Discharge Current 8x20µs(kA)	Insulation Resistance min. (GΩ)/ (Vdc)	Max. Capacitance C 1MHz(pF)
JTN28-075K	75±30%	600	20	20	1GΩ/50Vdc	1.5
JTN28-090K	90±20%	600	20	20	1GΩ/50Vdc	1.5
JTN28-150K	150±20%	600	20	20	1GΩ/50Vdc	1.5
JTN28-200K	200±20%	700	20	20	1GΩ/100Vdc	1.5
JTN28-230K	230±20%	700	20	20	1GΩ/100Vdc	1.5
JTN28-250K	250±20%	700	20	20	1GΩ/100Vdc	1.5
JTN28-350K	350±20%	1000	20	20	1GΩ/100Vdc	1.5
JTN28-420K	420±20%	1000	20	20	1GΩ/100Vdc	1.5
JTN28-470K	470±20%	1200	20	20	1GΩ/100Vdc	1.5
JTN28-500K	500±20%	1200	20	20	1GΩ/100Vdc	1.5
JTN28-600K	600±20%	1400	20	20	1GΩ/100Vdc	1.5



Electrical Performance

Item	Testing condition and method	Performance
DC Spark-over	Measure starting discharge voltage (Vs) by gradualy increasing applied	Meet specified
Voltage(Vs)	DC voltage. Test current is 1mA max. and test period is 1 second max.	value
	and the DC voltage ascend up within 100v/second.	
	Measure the insulation resistance across the terminal at regulated voltage	
Insulation	But The test voltage doesn't over the DC spark-over voltage with	1G Ω or over
Resistance(IR)	50Vdc/100Vdc/250Vdc/500Vdc.	
	Measure the electrostatic capacitance by applying a voltage	1.5pF or less
Capacitance	of less than 6V (at 1MHz)between terminals.	

The testing condition shall be subject to the following items:

- 1. Ambient Temp.:-40°C~125°C; Relative Humidity:<95%(40°CH);
- 2. Atmospheric Pressure 8.6×10⁴Pa~1.06×10⁴Pa.

Physical and Solderability Characteristics

Item	Testing condition and method	Performance		
Lead wire	Gradually applying the load 0.5Kg and keeping the unit		Meet DC spark-over voltage tolerance	
pull strength	fixed for 10±1sec.		Not pull out and break the lead wire.	
	The unit shall be secured with its lead wire kept vertical and t	the		
	0.25kg weight below be applied in the axial direction. The lead	d		
Lead wire	wire shall gradually be bend by 90 in onedirection at the point			
bending	of 3mm from the body along the radius of curvature Meet DC spark-over voltage toleral			
Strength	(0.75mm~0.8mm),and again back the original position.			
	The procedure shall be repeat 2times for 30sec.			
Solderability	After dipping the lead wire to a depth of 2mm from the body		Over 95% of the lead wire should	
	in a soldering bath of 260±5°C for 10±1 sec.		be covered with new solder.	
Resistance to	After dipping the lead wire to a depth of 2mm from the body			
soldering heat	in a soldering bath of 260±5°C for 10±1 sec.		Meet DC spark-over voltage tolerance.	

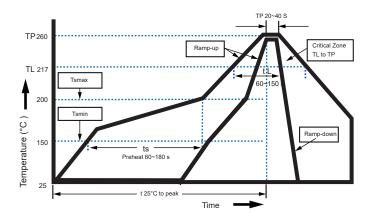


Environmental Characteristics

Item	Testing condition and method					Performance	
Resistance	The specimen shall be subjected to - 55±3°C for 1000 hours without load and				Meet specified value.		
to cold	then stored at roor	•				1	
Resistance	The specimen shall be subjected to 125±2°C for 1000 hours without load and Meet specified value				Meet specified value.		
to heat	then stored at roor	n temperature ar	nd humidity for	4 hours.			
Resistance	The specimen shall be subjected to 85±2°C 85%R.H.for 1000 hours without				Meet specified value.		
to humidity	load and then stored at room temperature and humidity for 4 hours.						
	Apply a impulse current (8/20µs of 20KA/10A/3KA) for 10 times at 60 seconds						No cracks or failures
Surge life	intervals,Thereafter, the characteristics of times Vs,IR and C shall be						after applying current
	measured(EN61000-4-5).						
	Repeat the temperature cycle shown below 200 times then store parts at room						
	temperature and humidity for 4 hours:						
Heat cycle	Ster	1	2	3	4		Meet specified value
	Temper	ature -55±3°C	Room Temp	125±2°C	Room Temp		weet specified value
	Peril	d 30min	30min	30min	30min		
Temperature	Operating temp range :-55°C to +125°C						
range	Storage temp range :-40°C to +85°C						



Soldering Parameters



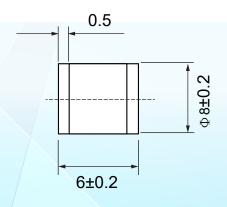
- Recommended reflow methods: IR, vapor phase oven, hot air oven, N2 environment for lead-free.
- Recommended maximum paste thickness is 0.25mm
 Devices can be cleaned using standard industry methods and solvents.
- Note 1:All temperature refer to topside of the package, measured on the package body surface.
- Note 2: If reflow temperatures exceed the recommended profile, devices may not meet the performance requirements.

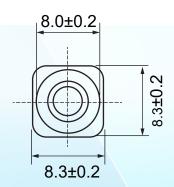
Profile Feature Pl	o-Free Assembly
Average Ramp-Up Rate	3°C/second mac.
(Ts max to T p)	
Preheat	
-Temperature Min(Ts min)	150°C
-Temperature Max(Ts max)	200°C
-Time(Ts min to Ts max)	60~180 seconds
Time maintained above:	
-Temperature(TL)	217°C
-Time(tL)	60~150 seconds
Peak Temperature(Tp)	260°C
Ramp-Down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max

Storage And Handling:

Storage conditions 0°C~ 35°C,30% ~60%R.H. Devices may not meet specified performance if storage conditions are exceeded.

Dimensions and Structure(mm)







Packaging

No.	Quantity &Packaging Code				
JTN28	400 pcs/reel				
		400pcs/reel			
	—				
4000pc	s/carton	800pcs/box			

Part Number System

